
SERIES 2000 STICK ANTENNA

FEATURES

- **Best in Class Performance Through Patented HDX Technology**
- **IP 64+ Protected**
- **2 Types Available**
- **Proven in Harsh Industrial Environments**
- **Easy to Install and Use**

APPLICATIONS

- **Access Control**
- **Vehicle Identification**
- **Container Tracking**
- **Asset Management**
- **Waste Management**



DESCRIPTION

These antenna products connect to Radio Frequency Modules (RFM) and reader/writers to form the interface to the low frequency (LF) 134.2 kHz Texas Instruments transponders. In combination with a reader/writer they transmit energy and signals to the transponder and receive the response from the tag. There are two standard stick antennas with 1 or 3 meter cable length available for usage in low frequency systems. Each antenna is capable of creating a specific size and shape of read zone to meet the requirements of the target application. Stick antennas provide a more focused read zone and an ability to discriminate between transponders.

The antennas are well suited for usage in a broad range of applications including, but not limited to, access control, vehicle identification, container tracking, asset management and waste management applications.



Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

ABSOLUTE MAXIMUM RATINGS

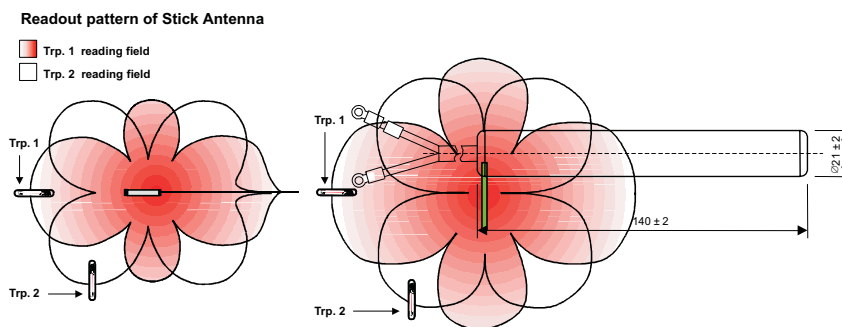
over operating free-air temperature range (unless otherwise noted)

	RI-ANT-S01C	RI-ANT-S02C	UNIT
Operating temperature	-30°C to +70°C	-30°C to +70°C	°C
Storage temperature	-40°C to +85°C	-40°C to +85°C	°C

OPERATING CHARACTERISTICS

over operating free-air temperature range (unless otherwise noted)

PARAMETER	PART NUMBER		UNIT
	RI-ANT-S01C	RI-ANT-S02C	
Type	Ferrite rod		
Inductance	Typically 27 μ H @ 134.2 kHz		
Protection class	IP66		
Vibration	Mil-Std -- 810 E, Test 514.4 (Category 1, Procedure 1; Basic transportation)		
Case material	Glass reinforced epoxy (grey)		
Dimensions	21 \pm 2 \times 140 \pm 2		mm
Weight	134	185	g
Cable Length	1	3	m
Connection terminals	Ring lugs: 3.5 mm inside diameter, 6 mm outside diameter		
Mounting	Use non-metal clamps. Mounting material is not supplied with the antenna.		



PACKAGING INFORMATION

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan (2)	Lead/Ball Finish (6)	MSL Peak Temp (3)	Op Temp (°C)	Device Marking (4/5)	Samples
RI-ANT-S01C-30	NRND			0	1	TBD	Call TI	Call TI	-30 to 70		
TRPGR30ATGA	ACTIVE	RFIDT	TGA	0	2000	Pb-Free (RoHS)	Call TI	N / A for Pkg Type	-25 to 70		Samples
TRPGR30ATGB	ACTIVE	RFIDT	TGB	0	2000	Pb-Free (RoHS)	Call TI	N / A for Pkg Type	-25 to 70		Samples
TRPGR30ENATGA	ACTIVE	RFIDT	TGA	0	2000	Pb-Free (RoHS)	Call TI	N / A for Pkg Type	-25 to 70		Samples
TRPGR30ENATGB	ACTIVE	RFIDT	TGB	0	2000	Pb-Free (RoHS)	Call TI	N / A for Pkg Type	-25 to 70		Samples

(1) The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

(2) **RoHS:** TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

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Green: TI defines "Green" to mean the content of Chlorine (Cl) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

(3) MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

(4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

(5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

(6) Lead/Ball Finish - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead/Ball Finish values may wrap to two lines if the finish value exceeds the maximum column width.

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